

SYSTEMBAUGRUPPE D1183 SYSTEM BOARD D1183

TECHNISCHES HANDBUCH
TECHNICAL MANUAL

Sie haben ...

... technische Fragen oder Probleme?

Wenden Sie sich bitte an:

- unsere Hotline:
Mo-Fr: 9 - 18 Uhr
Sa: 9 - 14 Uhr
Tel.: ++49 (0) 180 3777 000
- Ihren zuständigen Vertriebspartner
- Ihr Verkaufsstelle

Weitere Informationen finden Sie im Handbuch "Sicherheit, Garantie und Ergonomie".

Aktuelle Informationen zu unseren Produkten, Tipps, Updates usw. finden Sie im Internet:
<http://www.fujitsu-siemens.com>

Are there ...

... any technical problems or other questions you need clarified?

Please contact:

- your sales partner
- your sales outlet

You will find further information in the manual "Safety, Guarantee and Ergonomics".

The latest information on our products, tips, updates, etc., can be found on the Internet under:
<http://www.fujitsu-siemens.com>



Dieses Handbuch wurde auf Recycling-Papier gedruckt.
This manual has been printed on recycled paper.
Ce manuel est imprimé sur du papier recyclé.
Este manual ha sido impreso sobre papel reciclado.
Questo manuale è stato stampato su carta da riciclaggio.
Denna handbok är tryckt på recyclingpapper.
Dit handboek werd op recycling-papier gedrukt.

Herausgegeben von/Published by
Fujitsu Siemens Computers GmbH

Bestell-Nr./Order No.: **A26361-D1183-Z120-1-7419**

Printed in the Federal Republic of Germany

AG 0900 09/00



A26361-D1183-Z120-1-7419

Deutsch

English

**Systembaugruppe
D1183
System Board D1183**

**Technisches Handbuch
Technical Manual**

**Ausgabe September 2000
September 2000 edition**

Intel, Pentium und Celeron sind eingetragene Warenzeichen und MMX und OverDrive sind Warenzeichen der Intel Corporation, USA.

Microsoft, MS, MS-DOS und Windows sind eingetragene Warenzeichen der Microsoft Corporation.

PS/2 und OS/2 Warp sind eingetragene Warenzeichen von International Business Machines, Inc.

Alle weiteren genannten Warenzeichen sind Warenzeichen oder eingetragene Warenzeichen der jeweiligen Inhaber und werden als geschützt anerkannt.

Copyright © Fujitsu Siemens Computers GmbH 2000

Alle Rechte vorbehalten, insbesondere (auch auszugsweise) die der Übersetzung, des Nachdrucks, der Wiedergabe durch Kopieren oder ähnliche Verfahren.

Zu widerhandlungen verpflichten zu Schadenersatz.

Alle Rechte vorbehalten, insbesondere für den Fall der Patenterteilung oder GM-Eintragung.

Liefermöglichkeiten und technische Änderungen vorbehalten.

Dieses Handbuch wurde erstellt von
cognitas. Gesellschaft für Technik-Dokumentation mbH
www.cognitas.de

Intel, Pentium and Celeron are registered trademarks and MMX and OverDrive are trademarks of Intel Corporation, USA.

Microsoft, MS, MS-DOS and Windows are registered trademarks of Microsoft Corporation.

PS/2 and OS/2 Warp are registered trademarks of International Business Machines, Inc.

All other trademarks referenced are trademarks or registered trademarks of their respective owners, whose protected rights are acknowledged.

All rights, including rights of translation, reproduction by printing, copying or similar methods, even of parts are reserved.

Offenders will be liable for damages.

All rights, including rights created by patent grant or registration of a utility model or design, are reserved. Delivery subject to availability.

Right of technical modification reserved.

This manual was produced by
cognitas. Gesellschaft für Technik-Dokumentation mbH
www.cognitas.de

Contents

- Introduction.....1
 - Notational conventions1
- Important notes1
 - Information on boards.....2
- Features3
 - Interfaces and connectors5
 - Hard disk connection6
 - PCI bus interrupts.....7
 - Possible screen resolution7
- Settings with switches8
 - Recovering System BIOS - switch 28
 - Write protection for floppy disks - switch 38
- Add-on modules9
 - Installing / removing processor10
 - Upgrading main memory.....11
 - Upgrading GPA memory.....12
 - Installing network board with WOL.....12
 - Replacing the lithium battery.....13
- Glossary14

Introduction



Depending on the configuration of your system board, some of the hardware components described may not be available.

You may find further information in the description "BIOS Setup".

Further information to drivers is provided in the readme files on hard disk or on the supplied drivers diskettes or on the "Drivers & Utilities" or "ServerStart" CD.

Notational conventions

The meanings of the symbols and fonts used in this manual are as follows:



Pay particular attention to texts marked with this symbol. Failure to observe this warning endangers your life, destroys the system, or may lead to loss of data.



Supplementary information, remarks and tips follow this symbol.

- Texts which follow this symbol describe activities that must be performed in the order shown.
- ▬ This symbol means that you must enter a blank space at this point.
- ⏏ This symbol means that you must press the Enter key.

Texts in this typeface are screen outputs.

Texts in this bold typeface are the entries you make via the keyboard.

Texts in italics indicate commands or menu items.

"Quotation marks" indicate names of chapters and terms that are being emphasized.

Important notes

Store this manual close to the device. If you pass on the device to third parties, you should also pass on this manual.



Be sure to read this page carefully and note the information before you open the device.

You cannot access the components of the system board without first opening the device. How to dismantle and reassemble the device is described in the Operating Manual accompanying the device.

Please note the information provided in the chapter "Safety" in the Operating Manual of the device.

Incorrect replacement of the lithium battery may lead to a risk of explosion. It is therefore essential to observe the instructions in the chapter „[Add-on modules](#)“ - „[Replacing the lithium battery](#)“.



The shipped version of this board complies with the requirements of the EEC directive 89/336/EEC "Electromagnetic compatibility".

Compliance was tested in a typical PC configuration.

When installing the board, refer to the specific installation information in the Operating Manual or Technical Manual of the receiving device.

Connecting cables for peripherals must be adequately insulated to avoid interference.



Components can become very hot during operation. Make sure you do not touch components when making extensions to the system board. There is a danger of burns!



The warranty is invalidated if the device is damaged during the installation or replacement of system expansions. Information on which system expansions you can use is available from your sales outlet or the customer service center.

Information on boards

To prevent damage to the system board or the components and conductors on it, please take great care when you insert or remove boards. Take care above all to ensure that extension boards are slotted in straight without damaging components or conductors on the system board, or any other components, for example EMI spring contacts.

Be especially careful with the locking mechanisms (catches, centering pins etc.) when you replace the system board or components on it, for example memory modules or processors.

Never use sharp objects (screwdrivers) for leverage.



Boards with electrostatic sensitive devices (ESD) are identifiable by the label shown.

When you handle boards fitted with ESDs, you must observe the following points under all circumstances:

- You must always discharge yourself (e. g. by touching a grounded object) before working.
- The equipment and tools you use must be free of static charges.
- Pull out the power plug before inserting or pulling out boards containing ESDs.
- Always hold boards with ESDs by their edges.
- Never touch pins or conductors on boards fitted with ESDs.

Features

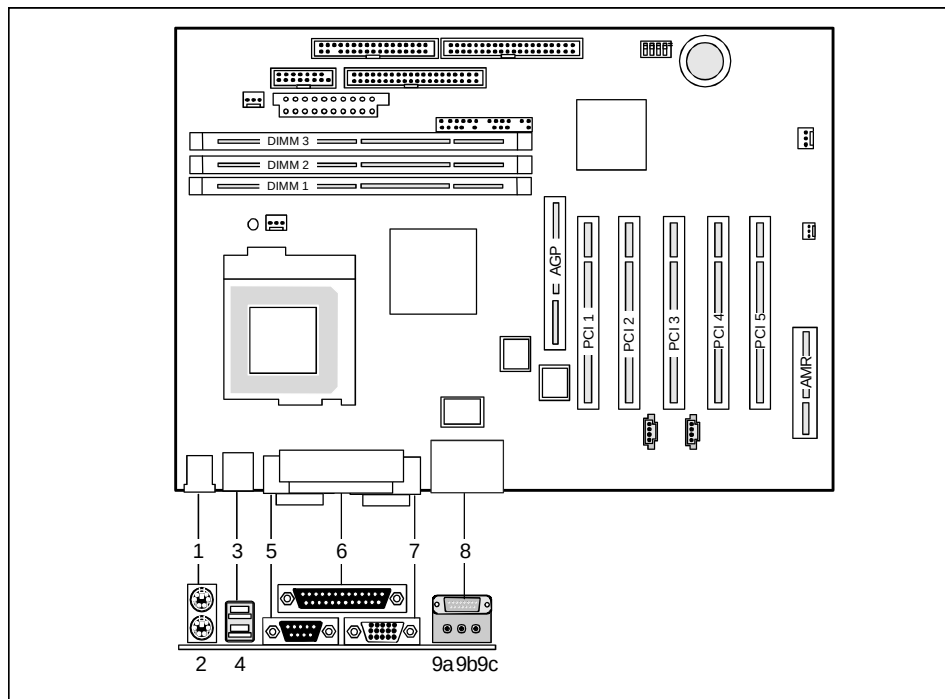
- System board in ATX format
- Intel Celeron processor with 66 MHz/100 MHz Front Side Bus for PGA 370 socket and Pentium III with 100 / 133 MHz Front Side Bus for PGA 370 socket.

Intel Celeron and Pentium III processors support MMX technology and Intel Streaming SIMD Extensions. Size and frequency of first-level cache and second-level cache are depending on the processor used.

- Intel chipset 815
consisting of GMCH 82815, ICH 82801 and FWH82802
- AC'97 Audio Codec
internal: Stereo CD-In, Stereo AUX-In
external: Mono Micro-In, Stereo Line-In, Game/Midi-Port, Stereo Line-Out (max. 2 x 0,5 W/8 Ω)
- 3 DIMM slots for 32 to 512 Mbyte main memory (SDRAM memory modules meet the PC100/PC133 specification) without ECC
- Flash BIOS
- Energy saving functions:
 - APM and ACPI (requires an operating system that supports ACPI)
 - Switching on/off, standby mode, suspend mode via on/off switch
 - Switching on/off via software
 - Wake on RTC
 - Wake on LAN
 - Wake on PCI Cards
- Security functions:
 - Chipcard reader interface
 - Cover monitoring: The cover monitoring reports when the cover has been opened without authorization.
 - System, Setup and Keyboard password
 - parallel and serial ports can be deactivated
 - Write protection for floppy disk drive
 - Virus warning function for the boot hard disk
 - Virus protection function for the flash BIOS and the EEPROMs on the memory modules
- 5 PCI slots
PCI slots support 3.3 V main and auxiliary voltages.
- 1 AGP slot
The AGP slot supports the 1x, 2x and 4x AGP mode or GPA memory modules. AGP slot supports 3.3 V main and auxiliary voltages.
- 1 AMR slot
- IDE hard disk controller connected to PCI bus for up to four IDE drives
(e.g. IDE hard disk drives, ATAPI CD-ROM drives)
The IDE hard disk controller are ATA33/66, ultra DMA capable and support PIO modes 0-4.
- Floppy disk drive controller (possible formats: 720 Kbyte, 1.44 Mbyte, 2.88 Mbyte)
- The system board supports booting from a 120 Mbyte IDE floppy disk drive.

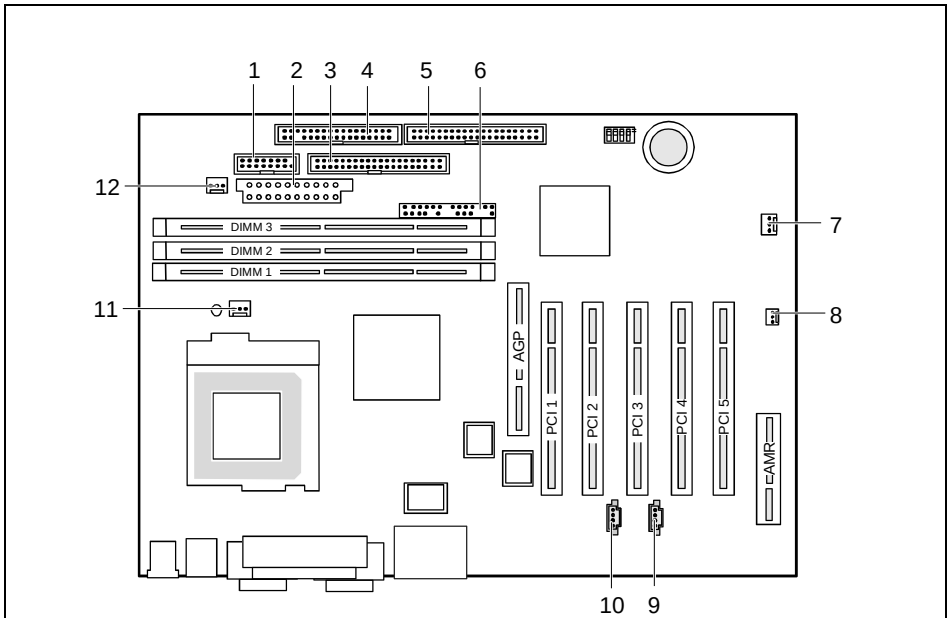
- 2D/3D graphics processor, 24 bit 230 MHz RAMDAC
GPA memory modules for enhanced 3D graphics performance is supported.
- Monitor connector: Sub D
- 1 external parallel interface (ECP- and EPP-compatible)
- 1 external serial port (16C550 compatible with FIFO)
- 1 internal chipcard reader interface.
As an alternative the chipcard reader interface can also be used as a second serial port (16C550 compatible with FIFO). This port does not support the ring indicator signal.
- 1 internal WOL interface
- 2 external PS/2 interfaces for keyboard and mouse
- 2 external USB ports
- Real-time clock/calendar with integrated battery backup

Interfaces and connectors



- 1 = PS/2 mouse port
- 2 = PS/2 keyboard port
- 3 = USB port 2
- 4 = USB port 1

- 5 = Serial port 1
- 6 = Parallel port
- 7 = VGA port
- 8 = Game/Midi port
- 9a = Audio Line-Out
- 9b = Audio Line-In
- 9c = Audio Micro-In



- | | |
|---|--------------------------------------|
| 1 = Chipcard reader interface or serial port 2 | 7 = Fan 2 (e. g. for the processor) |
| 2 = Power supply | 8 = Wake On LAN |
| 3 = IDE drives 3 and 4 (secondary) | 9 = CD audio input |
| 4 = Floppy disk drive | 10 = AUX audio input |
| 5 = IDE drives 1 and 2 (primary) | 11 = Fan 1 (e. g. for the processor) |
| 6 = Connector for control panel and loudspeaker | 12 = Cover monitoring |

The components and connectors marked are not necessarily present on the system board.

Hard disk connection

An ultra ATA/66 hard disk must be connected with a cable especially designed for the ATA/66 mode.

- Connect the blue marked end of the cable to the system board.

PCI bus interrupts

The following table shows which PCI bus interrupts on the system board are assigned.

PCI bus interrupt	Component on system board:
B, C, D, A	PCI bus slot 1
C, D, A, B	PCI bus slot 2
D, A, B, C	PCI bus slot 3
A, B, C, D	PCI bus slot 4
B, C, D, A	PCI bus slot 5
A, B	AGP slot
D	USB controller
A	Graphics processor
B	SMBus
B	AC'97 Audio

Possible screen resolution

Depending on the operating system used the screen resolutions in the following table refer to the screen controller on the system board.

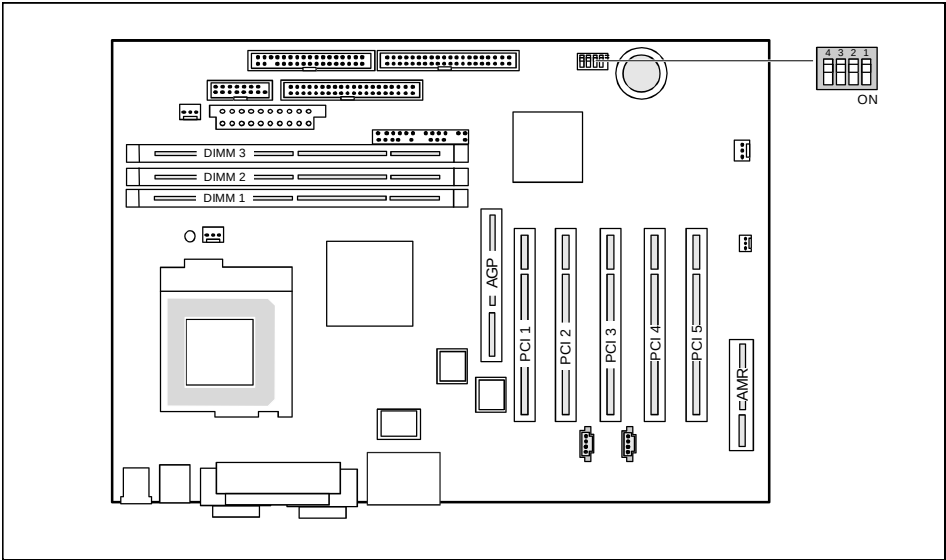
If you are using an external screen controller, you will find details of supported screen resolutions in the Operating Manual or Technical Manual supplied with the controller.

Screen resolution	Refresh rate (Hz)	Horizontal-rate (kHz) **	Max. number of colors
640x480	60 - 85	31,5 - 43,3	256
640x480	60 - 85	31,5 - 43,3	65 K
640x480	60 - 85	31,5 - 43,3	16,7 mio.
800x600	60 - 85	35,1 - 53,7	256
800x600	60 - 85	35,1 - 53,7	65 K
800x600	60 - 85	35,1 - 53,7	16,7 mio.
1024x768	60 - 85	48,8 - 68,7	256
1024x768	60 - 85	48,8 - 68,7	65 K
1024x768	60 - 85	48,8 - 68,7	16,7 mio.
1152x864	60 - 85	54,4 - 76,9	256
1152x864	60 - 85	54,4 - 76,9	65 K
1152x864	60 - 85	54,4 - 76,9	16,7 mio.
1280x1024	60 - 85	64,0 - 91,1	256
1280x1024	60 - 85	64,0 - 91,1	65 K
1280x1024	60 - 85	64,0 - 91,1	16,7 mio.
1600x1200	60 - 75	75,0 - 93,8	256

* no 16 color mode

** The horizontal rate values may have a tolerance range of ± 0.3 kHz.

Settings with switches



Switch 1 = must be set to *off*
Switch 2 = System BIOS recovery

Switch 3 = Write-protection for floppy disk
Switch 4 = must be set to *off*



The clock frequency of the processor is set automatically.

Recovering System BIOS - switch 2

Switch 2 enables recovery of the old system BIOS after an attempt to update has failed. To restore the old system BIOS you need a Flash BIOS Diskette (please call our customer service center).

- On* The System BIOS executes from floppy drive A: and the inserted "Flash-BIOS-Diskette" restores the System BIOS on the system board.
- Off* Normal operation (default setting).

Write protection for floppy disks - switch 3

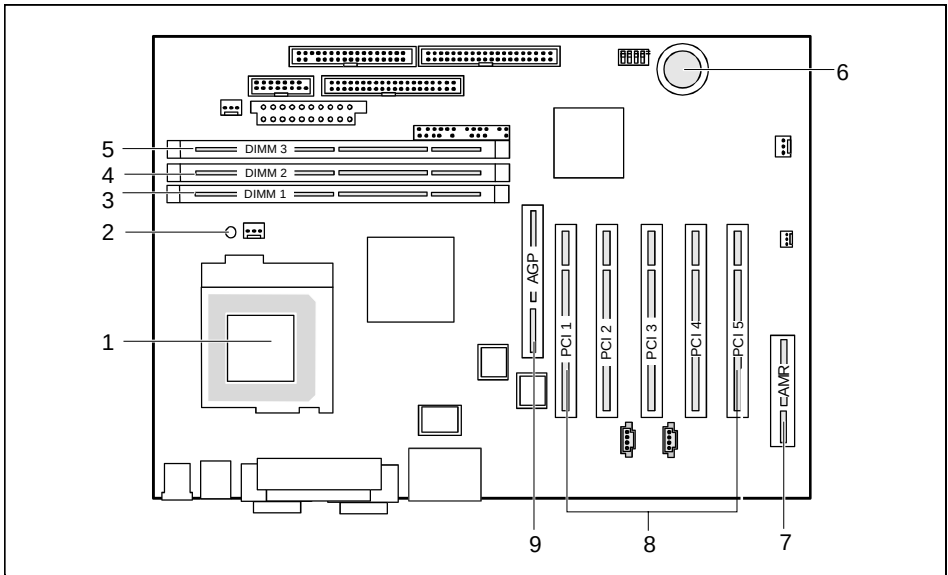
Switch 3 is used to define whether floppy disks can be written or deleted in the floppy disk drive. To write and delete floppy disks, the write-protection in *BIOS Setup* must be disabled (in menu *Security*, the field *Diskette Write* must be set to *Enabled*).

- On* The floppy disk drive is write-protected.
- Off* Read, write and delete floppy disks is possible (default setting).

Add-on modules



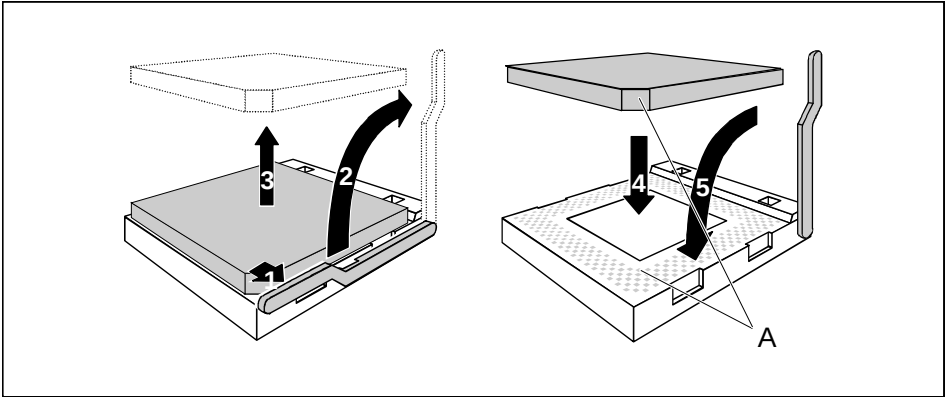
For all steps described in this chapter exit the suspend mode before switching off the device and then pull the power plug out of the power outlet!
Even when you have run down the device, parts of the device (e. g. memory modules, AGP and PCI extension boards) are still energized. Should this be the case, the voltage indicator LED glows.
All AGP and PCI slots support 3.3 V main and auxiliary voltages.



- 1 = Slot for processor with heat sink
- 2 = Voltage indicator LED
- 3 = Location bank 1 for main memory
- 4 = Location bank 2 for main memory

- 5 = Location bank 3 for main memory
- 6 = Lithium battery
- 7 = AMR slot
- 8 = PCI slots 1, 2, 3, 4, 5
- 9 = AGP slot

Installing / removing processor



- Push the lever in the direction of the arrow (1) and lift it as far as it will go (2).
- Remove the old processor from the socket (3).
- Insert the new processor in the socket so that the angled corner of the processor matches the coding on the socket (A) with regard to the position (4).



The angled corner of the processor may be covered by the heat sink. In this case let yourself be guided by the marking in the rows of pins on the underside of the processor.

- Push the lever back down so that it snaps into place (5).

Upgrading main memory

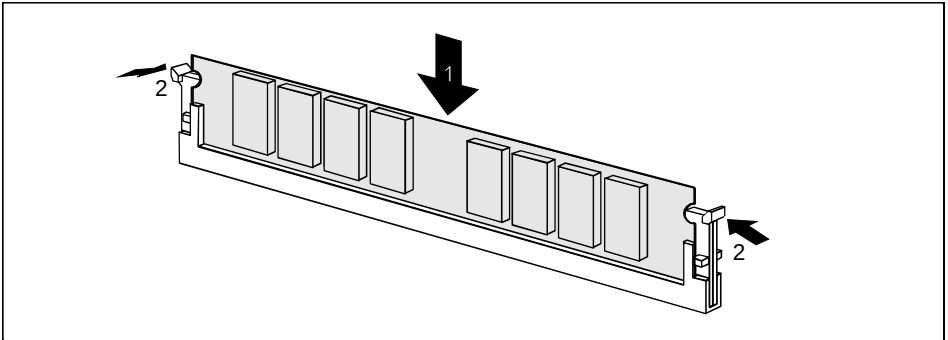
These slots are suitable for 16, 32, 64, 128 and 256 Mbyte memory modules of the DIMM format. Memory modules with different memory capacities can be combined.



You may only use unbuffered 3.3V memory modules. Buffered memory modules are not permitted.

SDRAM memory modules must meet the PC100/PC133 specification. If PC133 memory modules are used it is only allowed to apply 3 single sided or 2 double sided memory modules.

Installing memory modules

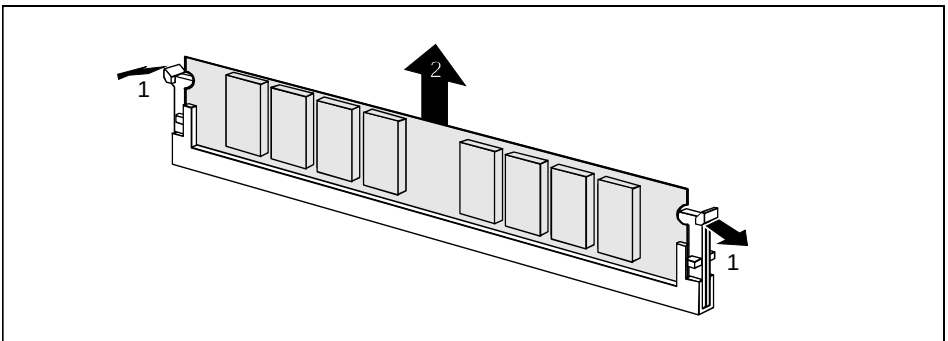


- ▶ Flip the holders on each side of the relevant location outwards.
- ▶ Insert the memory module into the location (1).

Watch the coding of the memory module when doing so.

- ▶ At the same time flip the lateral holders upwards until the memory module snaps in place (2).

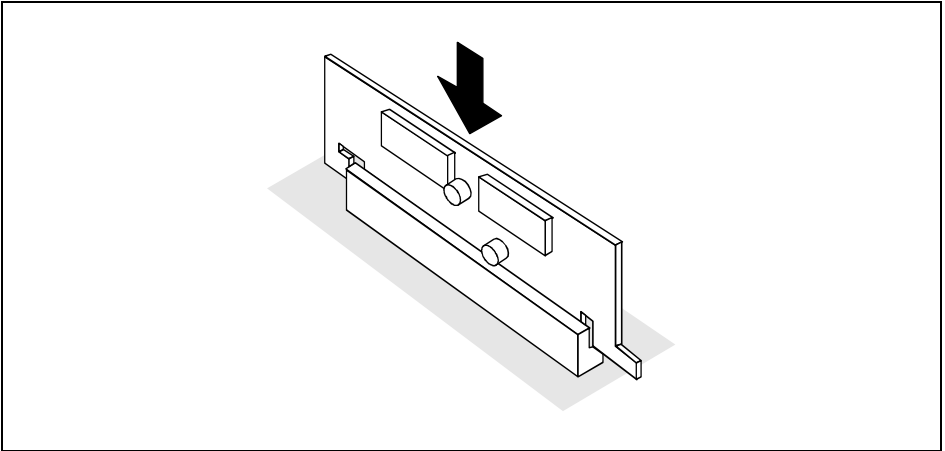
Removing a memory module



- ▶ Flip the holders to the right and left of the location outwards (1).
- ▶ Pull the memory module out of its location (2).

Upgrading GPA memory

The GPA memory (AIMM memory) improves the speed of the screen controller on the system board with 3D applications.



- Insert the memory module into the AGP slot (1)

Installing network board with WOL

- Install the network board as described in the operating manual for your unit.
- Push the WOL cable onto the WOL plug connector of the system board.



To use the WOL functionality of a network board the power supply must provide a 5 V auxiliary voltage of at least 1 A. If the system board was not already incorporated in a device when you bought it you must check whether your power supply can provide the auxiliary voltage.

You may find further information in the supplied description of the network board.

Replacing the lithium battery



Incorrect replacement of the lithium battery may lead to a risk of explosion.

The lithium battery must be replaced with an identical battery or a battery type recommended by the manufacturer (CR2032).

Do not throw lithium batteries into the trashcan. It must be disposed of in accordance with local regulations concerning special waste.

Make sure that you insert the battery the right way round. The plus pole must be on the top!

- **VAROITUS**

Paristo voi räjähtää, jos se on virheellisesti asennettu. Vaihda paristo ainoastaan laitevalmistajan suosittelemaan tyyppiin. Hävitä käytetty paristo valmistajan ohjeiden mukaisesti.

- **VARNING**

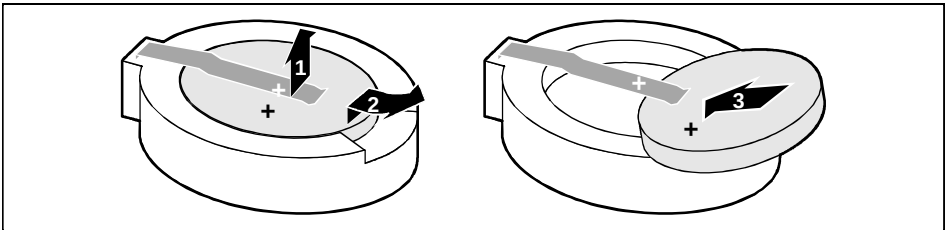
Explosionsfara vid felaktigt batteribyte. Använd samma batterityp eller en ekvivalent typ som rekommenderas av apparattillverkaren. Kassera använt batteri enligt fabrikantens instruktion.

- **ADVARSEL**

Lithiumbatteri - Explosionsfare ved fejlagtig håndtering. Udskiftning må kun ske med batteri af samme fabrikat og type. Lever det brugte batteri tilbage til leverandøren.

- **ADVARSEL**

Explosionsfare ved feilaktig skifte av batteri. Benytt samme batteritype eller en tilsvarende type anbefalt av apparatfabrikanten. Brukte batterier kasseres i henhold til fabrikantens instruksjoner.



- Lift the contact (1) a few millimeters and remove the battery from its socket (2).
- Insert a new lithium battery of the same type in the socket (3).

Glossary

The technical terms and abbreviations given below represent only a selection of the full list of common technical terms and abbreviations.

Not all technical terms and abbreviations listed here are valid for the described system board.

ACPI	Advanced Configuration and Power Management Interface
AC'97	Audio Codec '97
AGP	Accelerated Graphics Port
AIMM	AGP Inline Memory Module
AMR	Audio Modem Riser
AOL	Alert On LAN
APM	Advanced Power Management
ATA	Advanced Technology Attachment
BIOS	Basic Input Output System
CAN	Controller Area Network
CPU	Central Processing Unit
CNR	Communication Network Riser
C-RIMM	Continuity Rambus Inline Memory Module
DIMM	Dual Inline Memory Module
ECC	Error Correcting Code
EEPROM	Electrical Erasable Programmable Read Only Memory
FDC	Floppy Disk Controller
FIFO	First-In First-Out
FSB	Front Side Bus
FWH	Firmware Hub
GMCH	Graphics and Memory Controller Hub
GPA	Graphics Performance Accelerator
I ² C	Inter Integrated Circuit
IAPC	Instantly Available Power Managed Desktop PC Design
ICH	I/O Controller Hub
IDE	Intelligent Drive Electronics
IPSEC	Internet Protocol Security

ISA	Industrial Standard Architecture
LAN	Local Area Network
LSA	LAN Desk Service Agent
MCH	Memory Controller Hub
MMX	MultiMedia eXtension
P64H	PCI64 Hub
PCI	Peripheral Component Interconnect
PXE	Preboot eXecution Environment
RAM	Random Access Memory
RAMDAC	Random Access Memory Digital Analog Converter
RDRAM	Rambus Dynamic Random Access Memory
RIMM	Rambus Inline Memory Module
RTC	Real Time Clock
SB	Soundblaster
SDRAM	Synchronous Dynamic Random Access Memory
SGRAM	Synchronous Graphic Random Access Memory
SIMD	Streaming Mode Instruction (Single Instruction Multiple Data)
SMBus	System Management Bus
SVGA	Super Video Graphic Adapter
USB	Universal Serial Bus
VGA	Video Graphic Adapter
WOL	Wake On LAN